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# 捷多邦,专业PCB打样工厂,2名N5体局245,SN74F245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SDFS010A-MARCH 1987-REVISED OCTOBER 1993

SN54F245 ... J PACKAGE

- 3-State Outputs Drive Bus Lines Directly
- Package Options Include Plastic Small-Outline (SOIC) and Shrink Small-Outline (SSOP) Packages, Ceramic Chip Carriers, and Plastic and Ceramic DIPs

#### description

These octal bus transceivers are designed for asynchronous communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the logic level at the direction-control (DIR) input. The output enable  $(\overline{OE})$  input can be used to disable the device so the buses are effectively isolated.

The SN74F245 is available in TI's shrink small-outline package (DB), which provides the same I/O pin count and functionality of standard small-outline packages in less than half the printed-circuit-board area.

The SN54F245 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SN74F245 is characterized for operation from 0°C to 70°C.

SN74F245DB, DW, OR N PACKAGE (TOP VIEW)									
DIR [		20	Vcc						
A1 [	2	19	OE						
A2 [	3	18	B1						
A3 [	4	17	B2						
A4 [	5	16	B3						
A5 [	6	15	B4						
A6 [	7	14	B5						
A7 [	8	13	B6						
A8 [	9	12	B7						
GND [	10	11	B8						

#### SN54F245...FK PACKAGE (TOP VIEW)

		A2	A1	DIR	Vcc	Ю			
A3 A4 A5 A6 A7	4 5 7 8	3 9	2 10	1 1	20 12	19	18 17 16 16 15	B1 B2 B3 B4 B5	
		A8	GND	В	B7	BG			

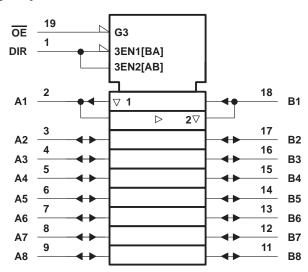
FU	NCT	ION	TAB	LE

	INP	UTS	OPERATION
31	OE	DIR	OFERATION
19	CL <sub>C</sub> ,	L	B data to A bus
	L	Н	A data to B bus
	Н	Х	Isolation

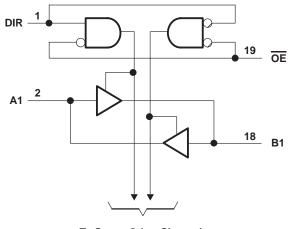


# SN54F245, SN74F245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS SDFS010A – MARCH 1987 – REVISED OCTOBER 1993

#### logic symbol<sup>†</sup>



logic diagram (positive logic)





<sup>†</sup> This symbol is in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

# absolute maximum ratings over operating free-air temperature range (unless otherwise noted)<sup>‡</sup>

Supply voltage range, $V_{CC}$ Input voltage range, $V_I$ (except I/O ports Input current range	) (see Note 1)	······ -	1.2 V to 7 V -30 mA to 5 mA
Voltage range applied to any output in th	•		
Voltage range applied to any output in the			
Current into any output in the low state:	SN54F245 (A1 thru A8)		40 mA
	SN54F245 (B1 thru B8)		96 mA
	SN74F245 (A1 thru A8)		48 mA
	SN74F245 (B1 thru B8)		128 mA
	. , ,		
	SN74F245		0°C to 70°C
Storage temperature range			

<sup>‡</sup> Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

NOTE 1: The input voltage ratings may be exceeded provided the input current ratings are observed.



# SN54F245, SN74F245 **OCTAL BUS TRANSCEIVERS** WITH 3-STATE OUTPUTS SDFS010A – MARCH 1987 – REVISED OCTOBER 1993

#### recommended operating conditions

			s	N54F24	5	SN74F245			UNIT
			MIN	NOM	MAX	MIN	NOM	MAX	UNIT
VCC	Supply voltage		4.5	5	5.5	4.5	5	5.5	V
VIH	High-level input voltage		2			2			V
VIL	Low-level input voltage				0.8			0.8	V
IIK	Input clamp current				-18			-18	mA
lau		A1 thru A8			- 3			- 3	mA
ЮН	High-level output current	B1 thru B8			- 12			- 15	mA
le:		A1 thru A8			20			24	A
IOL	Low-level output current	B1 thru B8			48			64	mA
Тд	Operating free-air temperature		-55		125	0		70	°C

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIONS		s	N54F24	5	S			
P/	RAMETER	IES	I CONDITIONS	MIN	TYP†	MAX	MIN	TYP <sup>†</sup>	MAX	UNIT
VIK		V <sub>CC</sub> = 4.5 V,	lj = -18 mA			-1.2			-1.2	V
	A1 thru A8		I <sub>OH</sub> = - 1 mA	2.5	3.4		2.5	3.4		
	AT thru Ao	V <sub>CC</sub> = 4.5 V	$I_{OH} = -3 \text{ mA}$	2.4	3.3		2.4	3.3		
VOH	B1 thru B8	V <sub>CC</sub> = 4.5 V	I <sub>OH</sub> = - 12 mA	2	3.2					V
	BT thru Bo	VCC = 4.5 V	I <sub>OH</sub> = - 15 mA				2	3.1		
	Any output	V <sub>CC</sub> = 4.75 V,	$I_{OH} = -1 \text{ mA to} - 3 \text{ mA}$				2.7			
	A1 thru A8	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 20 mA		0.3	0.5				0.5 V
Vai	AT thru Ao	VCC = 4.5 V	I <sub>OL</sub> = 24 mA					0.35	0.5	
VOL	B1 thru B8	V <sub>CC</sub> = 4.5 V	I <sub>OL</sub> = 48 mA		0.38	0.55				
	BT thru Bo	VCC = 4.5 V	I <sub>OL</sub> = 64 mA					0.42	0.55	
1.	A and B	V <sub>CC</sub> = 5.5 V	V <sub>I</sub> = 5.5 V			1			1	mA
łı	DIR, OE	VCC = 5.5 V	$V_{I} = 7 V$			0.1			0.1	mA
. +	A and B	V <sub>CC</sub> = 5.5 V,	V <sub>1</sub> = 2.7 V			70			70	μA
ι <sub>Η‡</sub>	DIR, OE	VCC = 5.5 V,	$v_{1} = 2.7 v_{2}$			20			20	μΑ
. +	A and B		V <sub>1</sub> = 0.5 V			-0.65			-0.65	mA
IIL‡	DIR, OE	V <sub>CC</sub> = 5.5 V,	v] = 0.5 v			- 1.2			- 1.2	ША
10.00	A1 thru A8			-60		-150	-60		-150	mA
IOS <sup>§</sup>	B1 thru B8	V <sub>CC</sub> = 5.5 V,	$V_{O} = 0$	-100		-225	-100		-225	mA
			Outputs high		70	90		70	90	
ICC		V <sub>CC</sub> = 5.5 V	Outputs low		95	120		95	120	mA
			Outputs disabled		85	110		85	110	

† All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.
‡ For I/O ports, the parameters I<sub>IH</sub> and I<sub>IL</sub> include the off-state output current.
§ Not more than one output should be shorted at a time, and the duration of the short circuit should not exceed one second.



# switching characteristics (see Note 2)

PARAMETER	FROM (INPUT)	то (OUTPUT)	CI RI	CC = 5 V _ = 50 pl _ = 500 s _ = 25°C	<b>F,</b> Ω,	CL RL	= 50 pF = 500 Ω		V,	UNIT	
				′ <b>F245</b>		SN54	F245	SN74	F245		
			[ [	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
<sup>t</sup> PLH	A or B	B or A	1.7	3.8	6	1.2	7.5	1.7	7	ns	
<sup>t</sup> PHL	AUB	BUR	1.7	4.2	6	1.2	7.5	1.7	7	115	
<sup>t</sup> PZH	ŌĒ	A or B	2.2	4.9	7	1.7	9	2.2	8		
<sup>t</sup> PZL	ÛE	AUB	2.7	5.6	8	2.2	10	2.7	9	ns	
<sup>t</sup> PHZ	ŌĒ	A or B	2.2	4.6	6.5	1.7	9	2.2	7.5	ns	
<sup>t</sup> PLZ	UE	AUIB	1.2	4.6	6.5	1.2	10	1.2	7.5	115	

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. NOTE 2: Load circuits and waveforms are shown in Section 1.



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